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Attorney

44,248  
Reg. No.

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Applicant : Nishimura  
Serial No. : 091750632  
Filed : November 24, 1999  
Title : LEAD FREE SOLDER ALLOY  
Docket : 550718-00070

Assistant Commissioner of Patents  
Washington, D.C. 20231

Sir:

PRELIMINARY AMENDMENT

Please enter the following amendment in the application filed herewith.

IN THE SPECIFICATION:

Page 1, line 1, please enter the following priority claim

-- Cross Reference to Related Applications

This application claims priority from related Japanese Patent Applications No. 10-324482 filed October 28, 1998; 10-324483 filed October 28 1998; and 10-100141 filed March 26, 1998. --

Page 4, line 19, change "Gallium" to read -- Germanium --.

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Favorable action on the merits is requested.

Respectfully submitted,



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